

CEI BTC8121

WAFER SORTING SYSTEM

APPLICATION:

➔ *Wafer sorting/packing & unpacking.*

FEATURES:

- *300mm ready*
- *Class 10 cleanliness*
- *Modular design for future expansion*
- *Capable of handling thin wafer*
- *GEM full compliance*
- *Enable full wafer integrity and traceability*
- *Eliminate human handling*
- *Reduces wafer loss and improve yield*
- *Safe, automated environment*

